

# FAST RECOVERY RECTIFIER DIODE

#### **MAJOR PRODUCTS CHARACTERISTICS**

<b>I</b> F(AV)	3 A
<b>V</b> <sub>RRM</sub>	400 V
t <sub>rr</sub>	25 ns
V <sub>F</sub> (max)	1.4 V

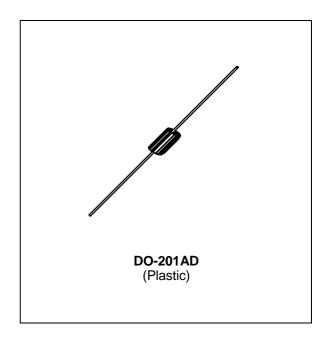
## **FEATURES**

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING

## **DESCRIPTION**

Free wheeling diode in converters and motor control circuits.

Rectifiers in S.M.P.S.



## **ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage		400	V
V <sub>RSM</sub>	Non repetitive peak reverse voltage		400	V
I <sub>FRM</sub>	Repetive peak forward current	60	Α	
I <sub>F (AV)</sub>	Average forward current*	$T_a = 65$ °C $\delta = 0.5$	3	Α
I <sub>FSM</sub>	Surge non repetitive forward current	60	Α	
Р	Power dissipation *	4.2	W	
T <sub>stg</sub>	Storage temperature range	- 40 to + 150	°C	
Tj	Maximum operating junction temperature	+ 150		

<sup>\*</sup> On infinite heatsink with 10mm lead lengh.

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# THERMAL RESISTANCES

,	Symbol	Parameter	Value	Unit
	R <sub>th (j - a)</sub>	Junction-ambient*	20	°C/W

<sup>\*</sup> On infinite heatsink with 10mm lead lengh.

# STATIC ELECTRICAL CHARACTERISTICS

Synbol	Test Conditions			Тур.	Max.	Unit
I <sub>R</sub>	T <sub>j</sub> = 25C	$V_R = V_{RRM}$			20	μΑ
	T <sub>j</sub> = 100C				0.5	mA
VF	T <sub>j</sub> = 25C	I <sub>F</sub> = 3A			1.5	V
	T <sub>j</sub> = 100C				1.4	

## **RECOVERY CHARACTERISTICS**

Symbol	Test Conditions			Тур.	Max.	Unit
t <sub>rr</sub>	T <sub>j</sub> = 25C	$I_F = 1A$ $di_F/dt = -15A/\mu s$ $V_R = 30V$			55	ns
		I <sub>F</sub> = 0.5A I <sub>R</sub> = 1 A I <sub>rr</sub> = 0.25A			25	

## TURN-OFF SWITCHING CHARACTERISTICS - Without series inductance

Symbol	Test	Min	. Тур.	Max.	Unit	
t <sub>IRM</sub>	di <sub>F</sub> /dt = - 50A/μs	$V_{CC} = 200 \text{ V}$ IF = 3A $L_D \le 0.05 \mu H$ $T_i = 100$	٥٠٠	35	50	ns
I <sub>RM</sub>	di <sub>F</sub> /dt = -50A/μs	$L_p \le 0.05 \mu H$ $T_j = 100$		1.5	2	А

To evaluate the conduction losse use the following equations :  $V_F = 1.1 + 0.050~I_F$   $P = 1.1~x~I_{F(AV)} + 0.050~I_F^2_{(RMS)}$ 

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**Fig. 1:** Maximum average power dissipation versus average forward current.

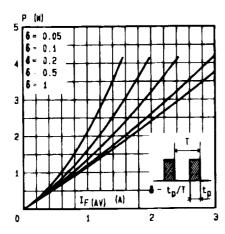
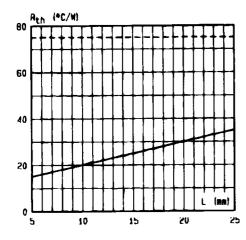


Fig.3: Thermal resistance versus lead length.



**Fig. 4:** Transient thermal impedance junction ambient for mounting  $n^{\circ}$  2 versus pulse duration (L = 10 mm).

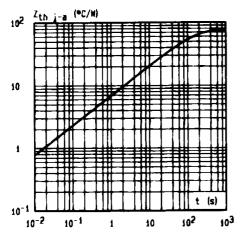
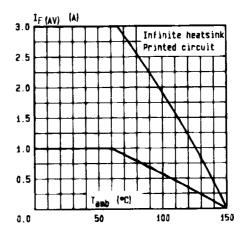
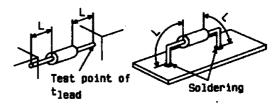


Fig. 2: Average forward current versus ambient temperature.



Mounting n°i Mounting n°2: INFINITE HEATSINK PRINTED CIRCUIT



**Fig. 5:** Peak forward current versus peak forward voltage drop (maximum values).

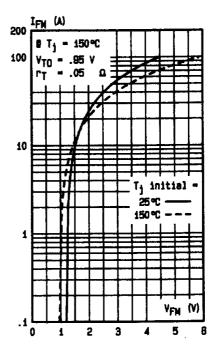


Fig. 7: Recovery time versus dl<sub>F</sub>/dt.

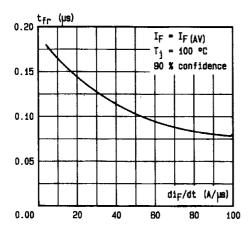
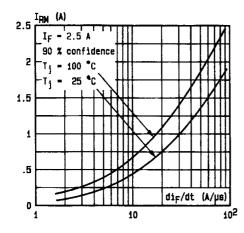


Fig. 9: Peak reverse current versus dl<sub>F</sub>/dt.



**Fig. 11:** Dynamic parameters versus junction temperature.

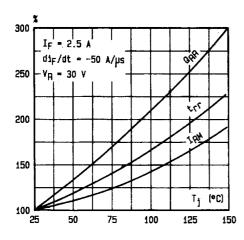
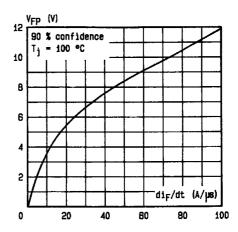
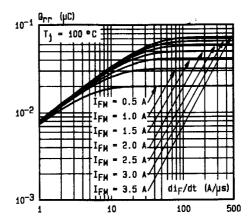


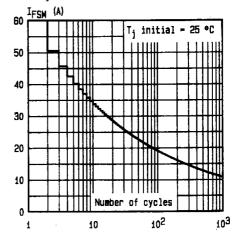
Fig. 8: Peak forward voltage versus dl<sub>F</sub>/dt.



**Fig. 10:** Recovery charge versus  $dI_F/dt$  (typical values).



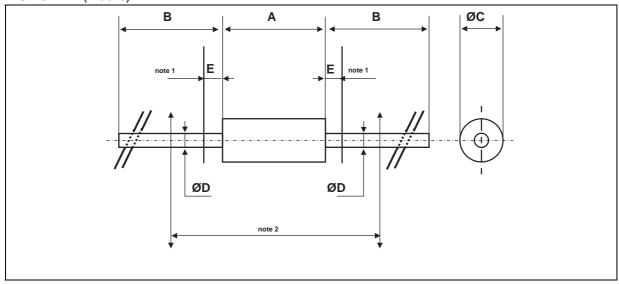
**Fig. 12:** Non repetitive surge peak current versus number of cycle.



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#### **PACKAGE MECHANICAL DATA**

DO-201AD (Plastic)



		DIMEN	SIONS		
REF.	Millimeters Inches		ters Inches		NOTES
	Min.	Max.	Min.	Max.	
Α		9.50		0.374	1 - The lead diameter Ø D is not controlled over zone E
В	25.40		1.000		2 - The minimum axial length within which the device may be
ØC		5.30		0.209	placed with its leads bent at right angles is 0.59"(15 mm)
Ø D		1.30		0.051	
E		1.25		0.049	

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